

### **Features**

- Epitaxial Planar Die Construction
- Ideally Suited for Automated Assembly Processes
- Complementary NPN Type Available (DST847BDJ)
- Lead, Halogen and Antimony Free, RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Ultra Small Package

#### **Mechanical Data**

- Case: SOT-963
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.0027 grams (approximate)

SOT-963



Top View



Device Schematic

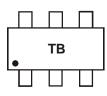
#### **Ordering Information**

Device	Packaging	Shipping
DST857BDJ-7	SOT-963	10,000/Tape & Reel

Notes: 1. No purposefully added lead. Halogen and Antimony Free.

2. Diodes Inc's "Green" Policy can be found on our website at http://www.diodes.com

# **Marking Information**



TB = Product Type Marking Code



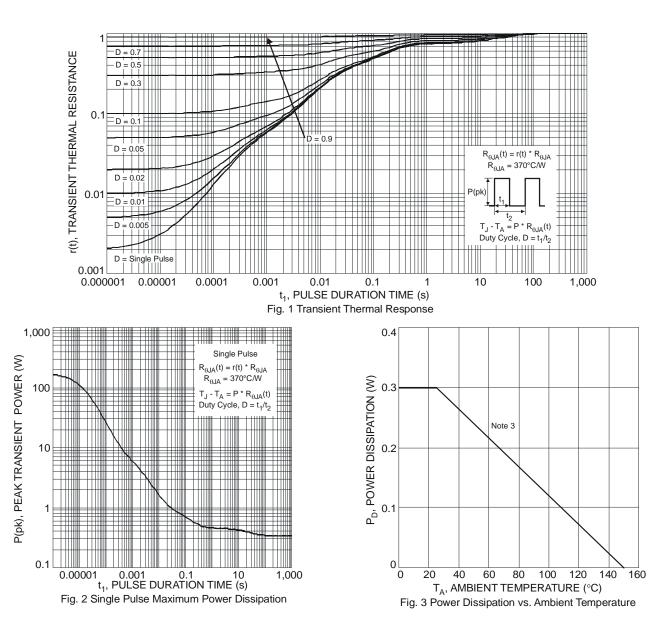
# **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-50	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-45	V
Emitter-Base Voltage	V <sub>EBO</sub>	-5.0	V
Collector Current - Continuous (Note 3)	Ιc	-100	mA

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3)	PD	300	mW
Thermal Resistance, Junction to Ambient (Note 3)	$R_{ extsf{ heta}JA}$	417	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

Notes: 3. Device mounted on FR-4 PCB with minimum recommended pad layout.

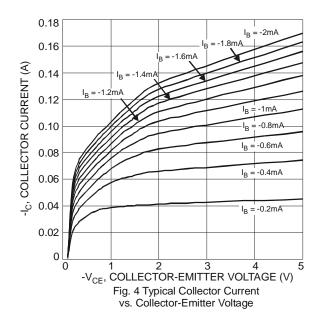


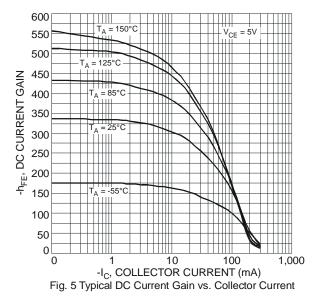


### **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic (Note 4)	Symbol	Min	Typical	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-50	-100	-	V	$I_{\rm C} = -10 \mu A, I_{\rm B} = 0$
Collector-Emitter Breakdown Voltage	V <sub>(BR)CES</sub>	-50	-90	-	V	$I_{C} = -10 \mu A, I_{B} = 0$
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	-45	-65	-	V	$I_{\rm C} = -1 {\rm mA},  I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	-6	-8.5	-	V	$I_E = -1\mu A$ , $I_C = 0$
Collector Cutoff Current	I <sub>CBO</sub>	-	-	-15	nA	V <sub>CB</sub> = -30V
DC Current Gain	hFE	100 200	340 330	- 470	-	$I_{C} = -10\mu A, V_{CE} = -5V$ $I_{C} = -2.0mA, V_{CE} = -5V$
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	-	-70 -300	-175 -500	mV	$I_{C}$ = -10mA, $I_{B}$ = -0.5mA $I_{C}$ = -100mA, $I_{B}$ = -5.0mA
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>		-760 -885	-1000 -1100	mV	$I_{C} = -10mA$ , $I_{B} = -0.5mA$ $I_{C} = -100mA$ , $I_{B} = -5.0mA$
Base-Emitter Voltage	V <sub>BE(on)</sub>	-600	-670 -715	-780 -850	mV	$I_{C} = -2.0 \text{mA}, V_{CE} = -5 \text{V}$ $I_{C} = -10 \text{mA}, V_{CE} = -5 \text{V}$
Current Gain-Bandwidth Product	f <sub>T</sub>	100	340	-	MHz	$V_{CE} = -5V, I_C = -10mA,$ f = 100MHz
Output Capacitance	Cobo	-	2.0	-	pF	V <sub>CB</sub> = -10V, f = 1.0MHz

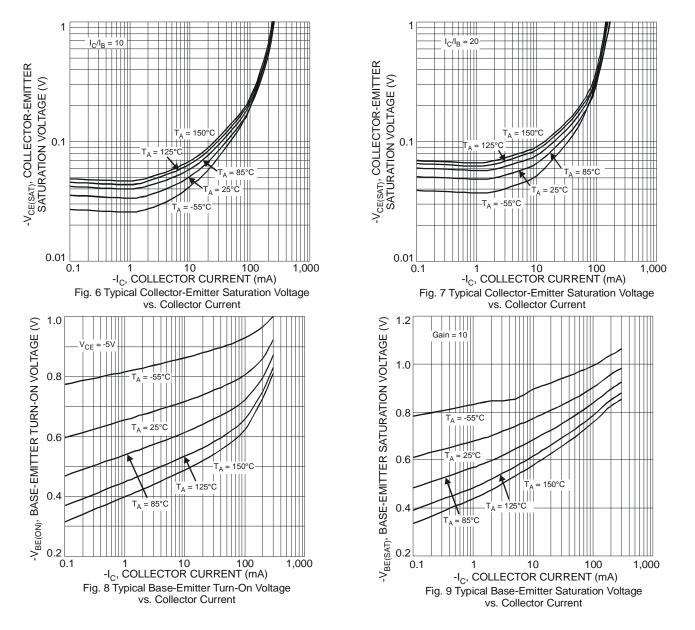
Notes: 4. Short duration pulse test used to minimize self-heating effect.



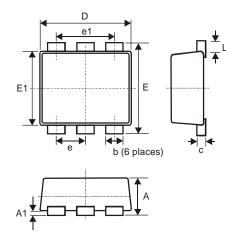




# DST857BDJ



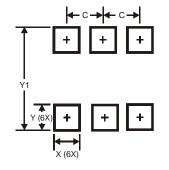
### **Package Outline Dimensions**



SOT-963				
Dim	Min	Max	Тур	
Α	0.40	0.50	0.45	
A1	0	0.05	-	
С	0.120	0.180	0.150	
D	0.95	1.05	1.00	
Е	0.95	1.05	1.00	
E1	0.75	0.85	0.80	
L	0.05	0.15	0.10	
b	0.10	0.20	0.15	
е	0.35 Typ			
e1	0.70 Тур			
All	All Dimensions in mm			



# Suggest Pad Layout



Dimensions	Value (in mm)
С	0.350
Х	0.200
Y	0.200
Y1	1.100

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